1-layer Copper-Carrier Kupfer-Träger



	solder mask	15 µm	Lacquer
Top L1	outer layer	35 µm	Copper
	prepreg	100 µm	Dielectric
	Copper Core	1500 µm	Copper

Total finished thickness:	**1,65 mm**
Tolerance ±	10%
Maximum thickness	1,82 mm
Minimum thickness	1,49 mm

Note:
The following options are available for copper thickness, prepreg and copper-core thickness:
Standards are marked **bold**

Hinweis:
Für Kupferdicke, Prepreg und Kupferkerndicke gibt es folgende Wahlmöglichkeiten:
Standards sind **fett** markiert

Copper thickness	**35** / 70 [µm]
Dielectric thickness	75 / **100** [µm]
Dielectric W/mK	**3,0 / 4,2 / 7,0 [W/mK]**
Copper Core thickness	1,0 / **1,5** [mm]
Alloy:	C1100

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